

BUF410

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- STMicroelectronics PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY
- VERY HIGH SWITCHING SPEED
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- LOW BASE-DRIVE REQUIREMENTS

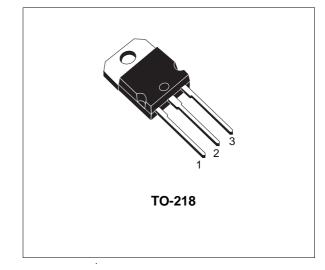
APPLICATIONS:

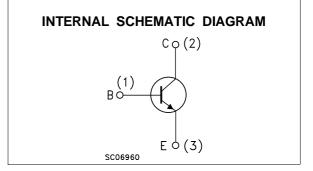
- SWITCH MODE POWER SUPPLIES
- MOTOR CONTROL

DESCRIPTION

The BUF410 is manufactured using High Voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capacity. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

The BUF series is designed for use in high-frequency power supplies and motor control applications.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CEV}	Collector-Emitter Voltage (V _{BE} = -1.5 V)	850	V
Vceo	Collector-Emitter Voltage (I _B = 0)	450	V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	7	V
lc	Collector Current	15	Α
Ісм	Collector Peak Current (t _p < 5 ms)	30	Α
Ι _Β	Base Current	3	A
I _{BM}	Base Peak Current (t _p < 5 ms)	4.5	A
P _{tot}	Total Dissipation at $T_c = 25$ °C	125	W
Tstg	Storage Temperature	-65 to 150	°C
Tj	Max Operation Junction Temperature	150	°C

THERMAL DATA

R _{thj-case} Thermal Resistance Junction-Case	Max	1	°C/W
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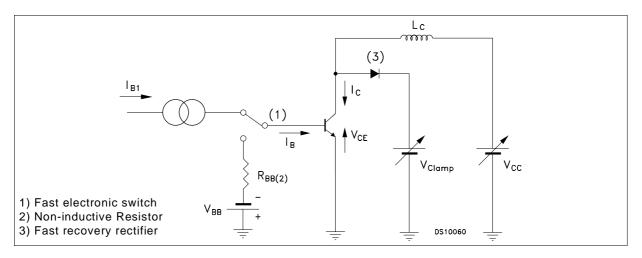
ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{o}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ICER	Collector Cut-off Current ($R_{BE} = 10 \Omega$)	$V_{CE} = 850 V$ $V_{CE} = 850 V$ $T_{C} = 100 °C$			0.2 1	mA mA
I _{CEV}	Collector Cut-off Current (V _{BE} = -1.5 V)	$V_{CE} = 850 V$ $V_{CE} = 850 V$ $T_{C} = 100 °C$			0.2 1	mA mA
I _{EBO}	Emitter Cut-off Current $(I_C = 0)$	V _{EB} = 5 V			1	mA
VCEO(sus)*	Collector-Emitter Sustaining Voltage (I _B = 0)	Ic = 200 mA L = 25 mH	450			V
V_{EBO}	Emitter Base Voltage (I _C = 0)	I _E = 50 mA	7			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage			0.8 0.5	2.8	V V V
		$I_{\rm C} = 10 \text{ A}$ $I_{\rm B} = 2 \text{ A}$ $T_{\rm C} = 100^{\circ} \text{C}$			2	V
V _{BE(sat)} *	Base-Emitter Saturation Voltage			0.9 1.1	1.5 1.5	V V V V
di _c /dt	Rate of rise on-state Collector Current	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	45 100	60		A/μs A/μs A/μs
V _{CE} (3µs)	Collector-Emitter Dynamic Voltage			2.1	8	V V
V _{CE} (5µs)	Collector-Emitter Dynamic Voltage			1.1	4	V V
ts tf tc	INDUCTIVE LOAD Storage Time Fall Time Cross Over Time			0.8 0.05 0.08		μs μs μs
ts t _f t _c	INDUCTIVE LOAD Storage Time Fall Time Cross Over Time				1.8 0.1 0.18	μs μs μs
V _{CEW}	Maximum Collector Emitter Voltage without Snubber		500			V
ts tf t _c	INDUCTIVE LOAD Storage Time Fall Time Cross Over Time			1.5 0.04 0.07		μs μs μs

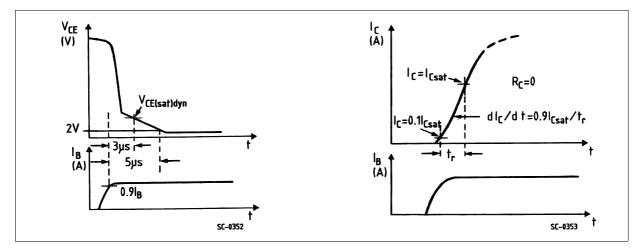
Symbol	Parameter	Test Co	Test Conditions		Тур.	Max.	Unit
ts t _f t _c	INDUCTIVE LOAD Storage Time Fall Time Cross Over Time	$I_{C} = 5 A$ $V_{BB} = 0$ $V_{clamp} = 400 V$ L = 0.5 mH	$V_{CC} = 50 V$ $R_{BB} = 0.3 \Omega$ $I_{B1} = 0.5 A$ $T_{C} = 100^{\circ}C$			3 0.15 0.25	μs μs μs
Vcew	Maximum Collector Emitter Voltage without Snubber	$I_{C} = 5 A$ $V_{BB} = 0$ $I_{B1} = 0.5 A$ $T_{C} = 125^{\circ}C$	$V_{CC} = 50 V$ $R_{BB} = 0.3 \Omega$ L = 0.5 mH	500			V
t _s t _f t _c	INDUCTIVE LOAD Storage Time Fall Time Cross Over Time	$I_{C} = 10 \text{ A} \\ V_{BB} = -5 \text{ V} \\ V_{clamp} = 400 \text{ V} \\ L = 0.25 \text{ mH}$	$V_{CC} = 50 V$ $R_{BB} = 1.2 \Omega$ $I_{B1} = 2 A$		1.9 0.06 0.12		μs μs μs
t _s t _f t _c	INDUCTIVE LOAD Storage Time Fall Time Cross Over Time	$I_{C} = 10 \text{ A} \\ V_{BB} = -5 \text{ V} \\ V_{clamp} = 400 \text{ V} \\ L = 0.25 \text{ mH}$	$V_{CC} = 50 V$ $R_{BB} = 1.2 \Omega$ $I_{B1} = 2 A$ $T_{C} = 100^{\circ}C$			3.2 0.12 0.3	μs μs μs
Vcew	Maximum Collector Emitter Voltage without Snubber	$I_{CWoff} = 15 A$ $V_{BB} = -5 V$ L = 0.1 mH $T_{C} = 125^{\circ}C$	V _{CC} = 50 V R _{BB} = 1.2 Ω I _{B1} = 3 A	400			V

ELECTRICAL CHARACTERISTICS (continued)

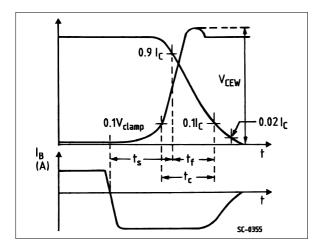
Inductive Load Switching Test Circuit



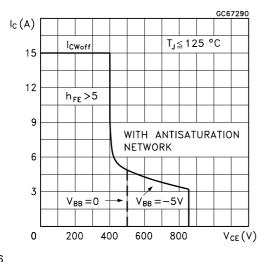
Turn-on Switching Test Waveforms.



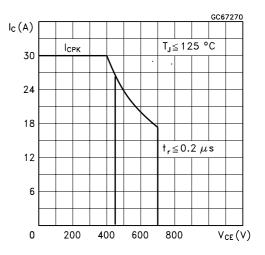
Turn-off SwitchingTest Waveforms (inductive load).



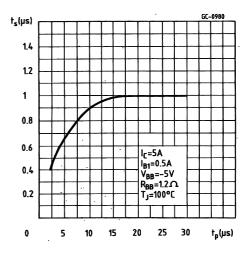
Reverse Biased Safe Operating Area



Forward Biased Safe Operating Areas.

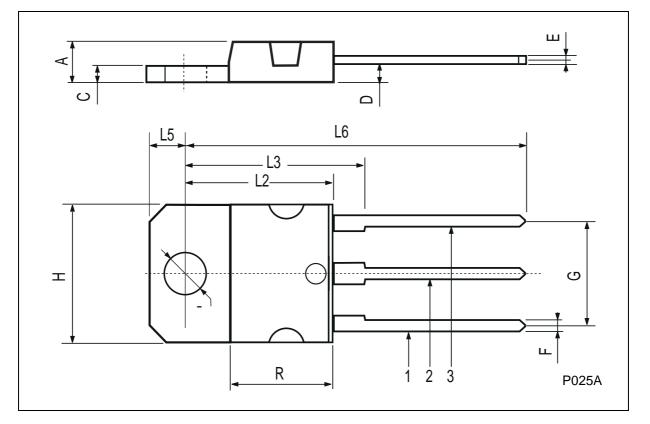


Storage Time Versus Pulse Time.



DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.7		4.9	0.185		0.193
С	1.17		1.37	0.046		0.054
D		2.5			0.098	
E	0.5		0.78	0.019		0.030
F	1.1		1.3	0.043		0.051
G	10.8		11.1	0.425		0.437
Н	14.7		15.2	0.578		0.598
L2	-		16.2	_		0.637
L3		18			0.708	
L5	3.95		4.15	0.155		0.163
L6		31			1.220	
R	-		12.2	_		0.480
Ø	4		4.1	0.157		0.161

TO-218 (SOT-93) MECHANICAL DATA



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